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File No. 14836-9US AD/JG/bns

Montréal, CANADA,
September 26, 2007RECEIVED
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SEP 26 2007**UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No : 10/532,627
Filing Date : April 25, 2005
Applicant : Microbridge Technologies Inc.
Inventor : Leslie M. Landsberger et al.
Title of Invention : METHOD FOR PRODUCING A PACKAGED INTEGRATED
CIRCUIT
Classification : 2822
Examiner : David E. Graybill Tel: (571) 272-1930
Patent Agent : Alexandra Daoud Tel: (514) 847-4333

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450
USA

RESPONSE

Sir:

In response to the Office Action dated June 27, 2007 in connection with the above-identified Application, please consider the following:

Remarks begin on page 2 of this paper